

04-01-2002



To the Honorable Commissioner of Patents  
Please record the attached original document

102038357

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):  
Kent Kuohua **CHANG**  
Name: Macronix International Co., Ltd.  
*3-21-02*

Additional name(s) of conveying party(ies) attached?  Yes  No Internal Address:

3. Nature of conveyance: Street Address: No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Assignment  Merger City:

Security Agreement  Change of Name State: Zip Code:

Other: Additional name(s) & Address(es) attached?  Yes  No

Execution Date: March 14, 2002  Yes  No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: March 14, 2002

A. Patent Application Number(s): **10,101931**  
B. Patent Number(s):  
Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed: 6. Total number of applications and registrations involved: 1

Name: Yitai Hu, Esq. 7. Total fee (37 CFR 3.41): \$40  
 Enclosed (Please charge deficiency to deposit account)  
 Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.  
Street Address: 1300 I Street, N.W., Ste. 700  
City: Washington, D.C.  
State: Zip: 20005-3315 8. Deposit Account No.: 06-0916

9. Statement and signature.  
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  
Yitai Hu  
Reg. No. 40,653  
*[Signature]*  
Signature  
March 21, 2002  
Date

Total number of pages including cover sheet, attachments and documents: 2

U.S. PTO  
10/101931  
03/21/02

**ASSIGNMENT**

WHEREAS I, the below named inventor, (hereinafter referred to as Assignor), have made an invention entitled:

**METHOD FOR FORMING AN OXIDE LAYER ON A NITRIDE LAYER**

for which I executed an application for United States Letters Patent concurrently herewith; and

WHEREAS, Macronix International Co., Ltd., a corporation of Taipei, Taiwan, R.O.C. whose post office address is No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I, as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention, provisional application Serial No.\_\_\_\_, filed \_\_\_\_ (if any), and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above provisional application (if any), as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I HEREBY authorize and request the attorneys I have empowered in the Declaration and Power of Attorney in this application to insert here in parentheses (Application No. \_\_\_\_\_, filed \_\_\_\_\_) the filing date and application number of said application when known.

Kuohua Kent Kobra <b>CHANG</b> FULL NAME OF FIRST INVENTOR KC	 INVENTOR'S SIGNATURE	3/14/2002 DATE
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